

Product Specification

Part No.: SCJ-2584-SMT-C, SCJ-2684-SMT-C

1) Rating: DC 30V 0.3A

2) Operating Temperature Range: $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$

3) Electrical Performance:

	Test Conditions	Performance
Contact Resistance	Measured at small current (10mA	$50 \mathrm{m}\Omega$ Max.
	1000Hz or less)	
Insulation Resistance	Apply a voltage of 500V DC	
	shall be applied for 1 minute after	100MΩ Min.
	which measurement taken:	
	(1) Between terminals not to	
	be contact	
	(2) Between body and	
	terminal	
	(3) Between terminals not to	
	be contact when plug is	
	inserted	
Dielectric Strength	AC500V rms (50-60Hz) for 1	
	minute trip current: 0.5mA	
	(1) Between terminals not to	
	be contact.	Without domage to ments ensing
	(2) Between body and	Without damage to parts arcing or breakdown
	terminal	
	(3) Between terminals not to	
	be contact when plug is	
	inserted.	

4) Mechanical Performance:

	Test Conditions	Performance
Insertion Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	700~1400gf
Extraction Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	500~1000gf
Terminal Strength	A static load of 300gf shall be applied to the terminal for 15 seconds in any direction	Electrical characteristics shall be satisfied without damage or excessive looseness of terminals
Life Test	Endurance without load: Jack shall be subjected to 5,000 cycles at a rate of 15 to 18 cycles per minute without loading.	 (1) Contact resistance: 100mΩ Max. (2) Insulation Resistance: 50MΩ Min. (3) Withstand Voltage: AC 500V



(4) Without damage to parts arcing or breakdown.
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5) Environmental Characteristics:

	Test Conditions	Performance
Solderability Test	The top of terminals shall be	The Area of soldering should be
	dipped 2mm in the solder bath of	over 75%
	255±5°C for 3±0.5 seconds	
Resistance to Solder Heat Test	Solder bath method: Solder temperature 260±5°C. Immersion time within 10 sec. Immersion depth up to the surface of the board 1.6mm. Dimensions of component holes in the printed wiring board shall being accordance with those	Without deformation of case or excessive looseness of terminals electrical characteristics shall be satisfied.
	specified in this specification.	
Cold Test	The jack shall be stored at a temperature of -25± 3°C for 48 hours, then the switch shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made	There shall be no deformation or
Heat Test	The jack shall be stored at a temperature of 70±2°C for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.	cracks in the molded part.
Humidity Test	The jack shall be stored at a temperature of 40±2°C and a humidity of 90% to 98% for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.	There shall be no deformation or cracks in molded part.
	Test Condition (Unless otherwise specifi	ied)
	Temperature: 5°C - 35°C	,
	Humidity: 45% - 85% R.H.	
	Pressure: 86 – 106kPa	